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** CONTINUING DATA *****

This application is a DIV of 09/380,312 08/31/1999
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** FOREIGN APPLICATIONS *****

JAPAN 9-171395 06/27/1997

JAPAN 10-73711 03/23/1998

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

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Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR	SHEETS	TOTAL	INDEPENDENT
35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after	COUNTRY	DRAWING	CLAIMS	CLAIMS
Verified and Acknowledged Allowance Examiner's Signature Initials	JAPAN	6	34	25

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TITLE

Resin molded type semiconductor device and a method of manufacturing the same

☐ All Fees

FILING FEE	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> 1.16 Fees (Filing)
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